

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Victor Seng Keong LIM</td> <td>11/18/2009</td> </tr> <tr> <td>Rachel Yie Fang WAI</td> <td>11/18/2009</td> </tr> <tr> <td>Fang Hong GN</td> <td>11/18/2009</td> </tr> <tr> <td>Liang Choo HSIA</td> <td>11/18/2009</td> </tr> </tbody> </table>		Name	Execution Date	Victor Seng Keong LIM	11/18/2009	Rachel Yie Fang WAI	11/18/2009	Fang Hong GN	11/18/2009	Liang Choo HSIA	11/18/2009
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>Chartered Semiconductor Manufacturing, Ltd.</td> </tr> <tr> <td>Street Address:</td> <td>60 Woodlands Industrial Park D Street 2</td> </tr> <tr> <td>City:</td> <td>Singapore</td> </tr> <tr> <td>State/Country:</td> <td>SINGAPORE</td> </tr> <tr> <td>Postal Code:</td> <td>738406</td> </tr> </table>		Name:	Chartered Semiconductor Manufacturing, Ltd.	Street Address:	60 Woodlands Industrial Park D Street 2	City:	Singapore	State/Country:	SINGAPORE	Postal Code:	738406
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CORRESPONDENCE DATA											
<p>Fax Number: (656)846-2005 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: +65 9836 9908</p> <p>Email: dexter.chin@horizonip.com.sg</p> <p>Correspondent Name: HORIZON IP PTE LTD</p> <p>Address Line 1: 7500A Beach Road</p> <p>Address Line 2: #04-306/308 The Plaza</p> <p>Address Line 4: SINGAPORE, SINGAPORE 199591</p>											
ATTORNEY DOCKET NUMBER:	CSM P 2009 NAT 58 US 0										
NAME OF SUBMITTER:	Dexter CHIN										
Total Attachments: 5											

CH \$40.00 12621513

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PATENT
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ASSIGNMENT

For good and valuable consideration, we, Victor Seng Keong LIM, residing at Blk 654B Jurong West Street 61, #15-486, Singapore 642654, a citizen of Singapore; Rachel Yie Fang WAI, residing at 21 Rosewood Drive, Tower 1 #15-02, Casablanca Condominium, Singapore 737917, a citizen of Malaysia; Fang Hong GN, residing at 59 West Coast Way, #09-14 Singapore 127019, a citizen of Singapore; Liang Choo HSIA, residing at 22 Woodgrove Avenue, Singapore 738064, a citizen of United States of America;

Hereby sell, assign, and transfer to **Chartered Semiconductor Manufacturing, Ltd.**, a corporation of **Singapore**, having its principal place of business at **60 Woodlands Industrial Park D Street 2, Singapore 738406**,

hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently here within, and is entitled:

TEST CHIPLETS FOR DEVICES

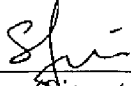
and in and to said application and all divisional, continuing substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

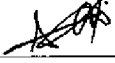
Agree that Assignee may apply for and receive Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of said Assignee, their successors, assigns, and legal representatives to carry out in good faith the intent and purpose of this agreement, the undersigned will execute all divisional, continuing substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers;

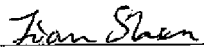
communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: 18/11/2009


(Signature)
Victor Seng Keong LIM

Witness 1: 
(Signature)
Lai Keng Heng
(Print name)

Witness 2: 
(Signature)
Shen Jian
(Print name)

Date:

18/11/2008


(Signature)

Rachel Yie Fang **WAI**

Witness 1:


(Signature)

Lai Keng Heng
(Print name)

Witness 2:


(Signature)

Shen Jian
(Print name)

Date:

18/11/09



(Signature)

Fang Hong GN

Witness 1:

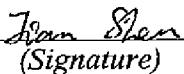


(Signature)

Lai Keng Heng

(Print name)

Witness 2:



(Signature)

Shen Tsun

(Print name)

Date:

18/11/2009



(Signature)

Liang Choo HSIA

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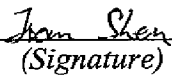


(Signature)

Lai Keng Heng

(Print name)

Witness 2:



(Signature)

Shen Jiem

(Print name)